

Advanced Regulating Pulse Width Modulators

FEATURES

- Fully Interchangeable with Standard UC1524 Family
- Precision Reference Internally Trimmed to $\pm 1\%$
- High-Performance Current Limit Function
- Under-Voltage Lockout with Hysteretic Turn-on
- Start-Up Supply Current Less Than 4mA
- Output Current to 200mA
- 60V Output Capability
- Wide Common-Mode Input Range for both Error and Current Limit Amplifiers
- PWM Latch Insures Single Pulse per Period
- Double Pulse Suppression Logic
- 200ns Shutdown through PWM Latch
- Guaranteed Frequency Accuracy
- Thermal Shutdown Protection

DESCRIPTION

The UC1524A family of regulating PWM ICs has been designed to retain the same highly versatile architecture of the industry standard UC1524 (SG1524) while offering substantial improvements to many of its limitations. The UC1524A is pin compatible with "non-A" models and in most existing applications can be directly interchanged with no effect on power supply performance. Using the UC1524A, however, frees the designer from many concerns which typically had required additional circuitry to solve.

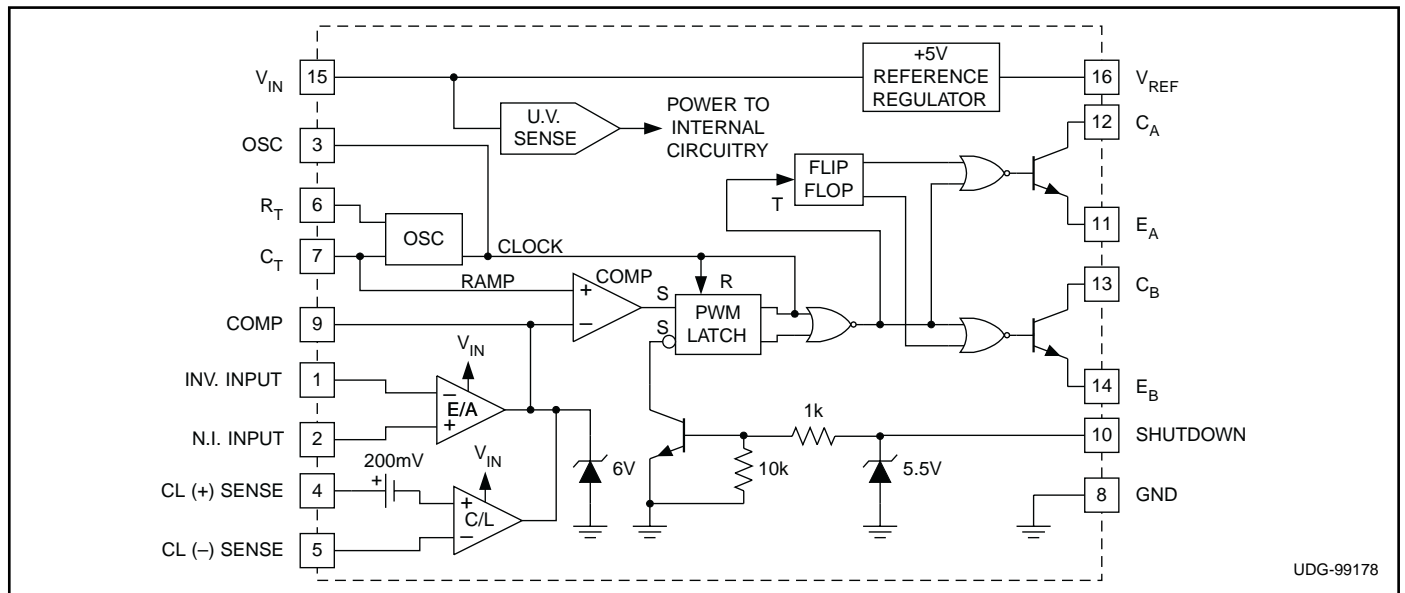
The UC1524A includes a precise 5V reference trimmed to $\pm 1\%$ accuracy, eliminating the need for potentiometer adjustments; an error amplifier with an input range which includes 5V, eliminating the need for a reference divider; a current sense amplifier useful in either the ground or power supply output lines; and a pair of 60V, 200mA uncommitted transistor switches which greatly enhance output versatility.

An additional feature of the UC1524A is an under-voltage lockout circuit which disables all the internal circuitry, except the reference, until the input voltage has risen to 8V. This holds standby current low until turn-on, greatly simplifying the design of low power, off-line supplies. The turn-on circuit has approximately 600mV of hysteresis for jitter-free activation.

Other product enhancements included in the UC1524A's design include a PWM latch which insures freedom from multiple pulsing within a period, even in noisy environments, logic to eliminate double pulsing on a single output, a 200ns external shutdown capability, and automatic thermal protection from excessive chip temperature. The oscillator circuit of the UC1524A is usable beyond 500kHz and is now easier to synchronize with an external clock pulse.

The UC1524A is packaged in a hermetic 16-pin DIP and is rated for operation from -55°C to $+125^{\circ}\text{C}$. The UC2524A and 3524A are available in either ceramic or plastic packages and are rated for operation from -40°C to $+85^{\circ}\text{C}$ and 0°C to 70°C , respectively. Surface mount devices are also available.

BLOCK DIAGRAM



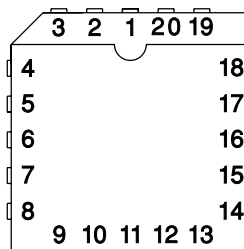
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ABSOLUTE MAXIMUM RATINGS

Supply Voltage (VIN) 40V
 Collector Supply Voltage (Vc) 60V
 Output Current (each Output) 200mA
 Maximum Forced Voltage (Pin 9, 10) -3 to +5V
 Maximum Forced Current (Pin 9, 10) ±10mA
 Reference Output Current 50mA
 Oscillator Charging Current 5mA
 Power Dissipation at TA = +25°C 1000mW
 Power Dissipation at Tc = +25°C 2000mW
 Operating Temperature Range -55°C to +125°C
 Storage Temperature Range -65°C to +150°C
 Lead Temperature, (Soldering, 10 seconds) +300°C
Note: Consult packaging section of Databook for thermal limitations and considerations of package.

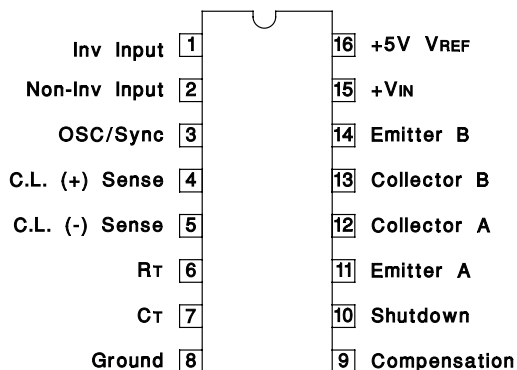
CONNECTION DIAGRAMS

**PLCC-20, LCC-20 (TOP VIEW)
Q or L Package**



PACKAGE PIN FUNCTION	
FUNCTION	PIN
N/C	1
Inv. Input	2
Non-Inv. Input	3
OSC/SYNC	4
C.L. (+) sense	5
N/C	6
C.L. (-) sense	7
RT	8
CT	9
Ground	10
N/C	11
Compensation	12
Shutdown	13
Emitter A	14
Collector A	15
N/C	16
Collector B	17
Emitter B	18
+VIN	19
+5V VREF	20

**DIL-16, SOIC-16 (TOP VIEW)
J or N Package, DW Package**



ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these specifications apply for TA = -55°C to +125°C for the UC1524A, -40° to +85°C for the UC2524A, and 0°C to + 70°C for the UC3524A; VIN = Vc = 20V, TA = TJ.

PARAMETER	TEST CONDITIONS	UC1524A / UC2524A			UC3524A			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
Turn-on Characteristics								
Input Voltage	Operating Range after Turn-on	8		40	8		40	V
Turn-on Threshold		6.5	7.5	8.5	6.5	7.5	8.5	V
Turn-on Current	VIN = 6V		2.5	4		2.5	4	mA
Operating Current	VIN = 8 to 40V		5	10		5	10	mA
Turn-on Hysteresis*			0.5			0.5		V
Reference Section								
Output Voltage	TJ = 25°C	4.95	5.00	5.05	4.90	5.00	5.10	V
	Over Operating Range	4.9		5.1	4.85		5.15	V
Line Regulation	VIN = 10 to 40V		10	20		10	30	mV
Load Regulation	IL = 0 to 20 mA		20	25		20	35	mV
Temperature Stability*	Over Operating Range*		20	25		20	35	mV
Short Circuit Current	VREF = 0, 25°C ≤ TJ ≤ 125°C		80	100		80	100	mA
Output Noise Voltage*	10Hz ≤ f ≤ 10kHz, TJ = 25°C		40			40		μVrms
Long Term Stability*	TJ = 125°C, 1000 Hrs.		20	50		20	50	mV

* These parameters are ensured by design but not 100% tested in production.

ELECTRICAL CHARACTERISTICS: Unless otherwise stated, these specifications apply for $T_A = -55^{\circ}\text{C}$ to $+125^{\circ}\text{C}$ for the UC1524A, -40° to $+85^{\circ}\text{C}$ for the UC2524A, and 0°C to $+70^{\circ}\text{C}$ for the UC3524A; $V_{IN} = V_C = 20\text{V}$, $T_A = T_J$.

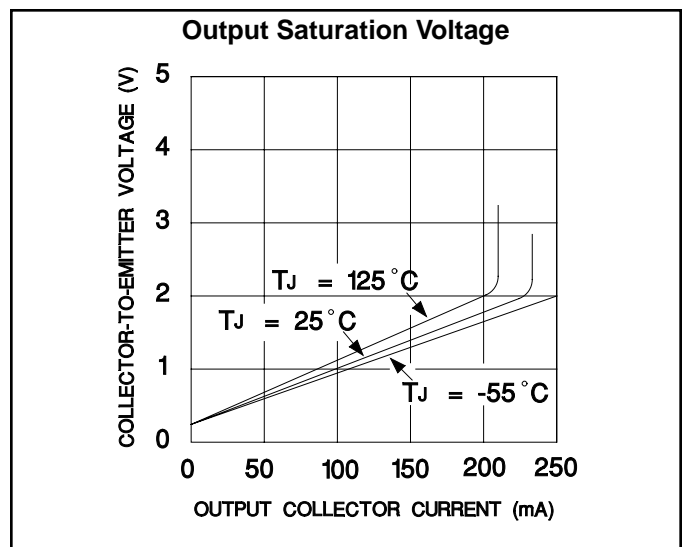
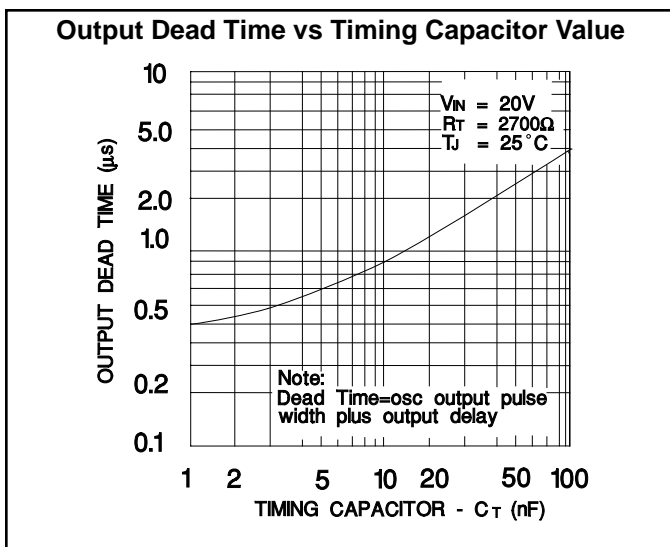
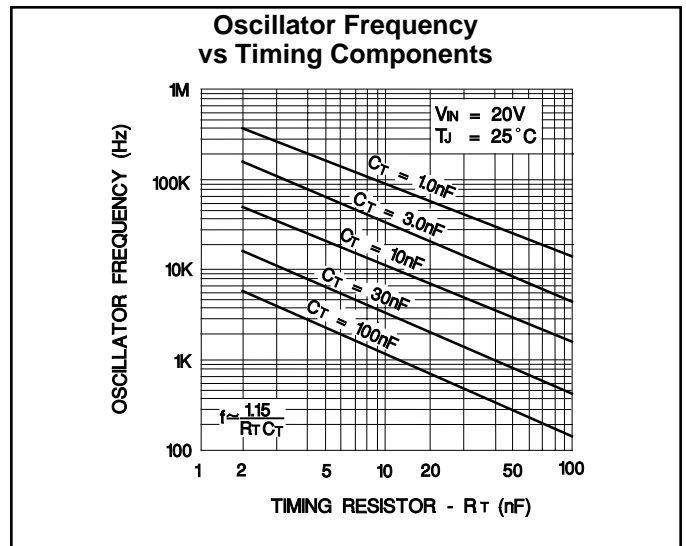
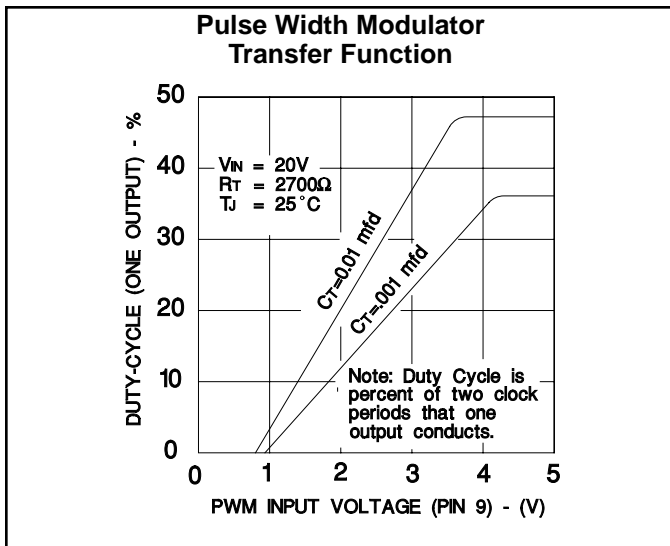
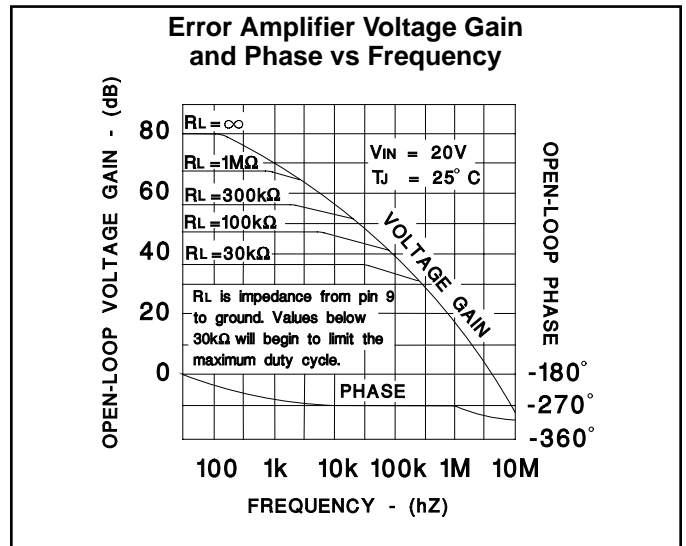
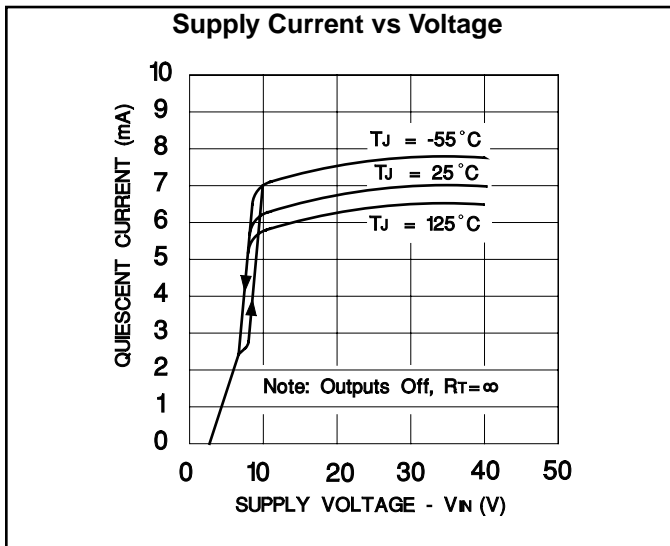
PARAMETER	TEST CONDITIONS	UC1524A / UC2524A			UC3524A			UNITS
		MIN	TYP	MAX	MIN	TYP	MAX	
Oscillator Section (Unless otherwise specified, $R_T = 2700\Omega$, $C_T = 0.01\text{ mfd}$)								
Initial Accuracy	$T_J = 25^{\circ}\text{C}$	41	43	45	39	43	47	kHz
	Over Operating Range	40.2		45.9	38.2		47.9	kHz
Temperature Stability*	Over Operating Temperature Range		1	2		1	2	%
Minimum Frequency	$R_T = 150\text{k}\Omega$, $C_T = 0.1\text{ mfd}$			140			120	Hz
Maximum Frequency	$R_T = 2.0\text{k}\Omega$, $C_T = 470\text{pF}$	500			500			kHz
Output Amplitude*		3	3.5		3	3.5		V
Output Pulse Width*		0.29	0.5	1.0	0.3	0.5	1.0	μs
Ramp Peak		3.3	3.5	3.7	3.3	3.5	3.7	V
Ramp Valley	$T_J = 25^{\circ}\text{C}$	0.7	0.8	0.9	0.7	0.8	0.9	V
Ramp Valley T.C.			-1.0			-1.0		$\text{mV}/^{\circ}\text{C}$
Error Amplifier Section (Unless otherwise specified, $V_{CM} = 2.5\text{V}$)								
Input Offset Voltage			0.5	5		2	10	mV
Input Bias Current			1	5		1	10	μA
Input Offset Current			.05	1		0.5	1	μA
Common Mode Rejection Ratio	$V_{CM} = 1.5$ to 5.5V	70	80		70	80		dB
Power Supply Rejection Ratio	$V_{IN} = 10$ to 40V	70	80		70	80		dB
Output Swing (Note 1)		5.0		0.5	5.0		0.5	V
Open Loop Voltage Gain	$\Delta V_O = 1$ to 4V , $R_L \geq 10\text{M}\Omega$	72	80		64	80		dB
Gain-Bandwidth*	$T_J = 25^{\circ}\text{C}$, $A_V = 0\text{dB}$	1	3		1	3		MHz
DC Transconductance*§	$T_J = 25^{\circ}\text{C}$, $30\text{k}\Omega \leq R_L \leq 1\text{M}\Omega$	1.7	2.3		1.7	2.3		mS
P.W.M. Comparator ($R_T = 2\text{k}\Omega$, $C_T = 0.01\text{ mfd}$)								
Minimum Duty Cycle	$V_{COMP} = 0.5\text{V}$			0			0	%
Maximum Duty Cycle	$V_{COMP} = 3.8\text{V}$	45			45			%
Current Limit Amplifier (Unless otherwise specified, Pin 5 = 0V)								
Input Offset Voltage	$T_J = 25^{\circ}\text{C}$, E/A Set for Maximum Output	190	200	210	180	200	220	mV
	Over Operating Temperature Range	180		220	170		230	mV
Input Bias Current			-1	-10		-1	-10	μA
Common Mode Rejection Ratio	$V_{(\text{pin } 5)} = -0.3\text{V}$ to $+5.5\text{V}$	50	60		50	60		dB
Power Supply Rejection Ratio	$V_{IN} = 10$ to 40V	50	60		50	60		dB
Output Swing (Note 1)	Minimum Total Range	5.0		0.5	5.0		0.5	V
Open-Loop Voltage Gain	$\Delta V_O = 1$ to 4V , $R_L \geq 10\text{M}\Omega$	70	80		70	80		dB
Delay Time*	Pin 4 to Pin 9, $\Delta V_{IN} = 300\text{mV}$		300			300		ns
Output Section (Each Output)								
Collector Emitter Voltage	$I_C = 100\mu\text{A}$	60	80		60	80		V
Collector Leakage Current	$V_{CE} = 50\text{V}$.1	20		.1	20	μA

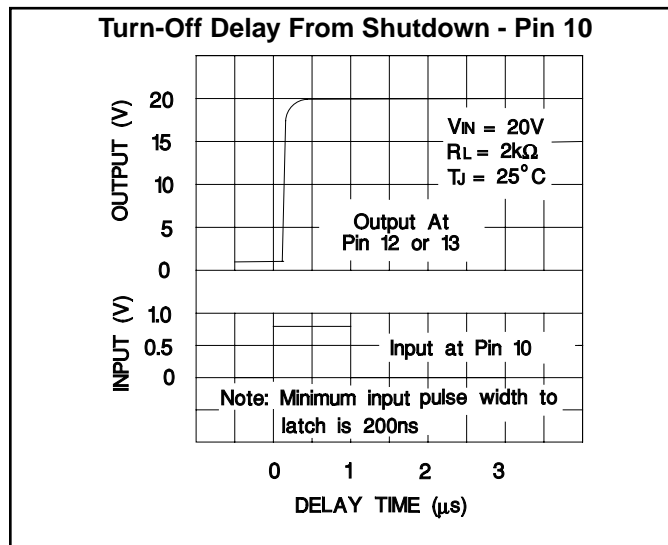
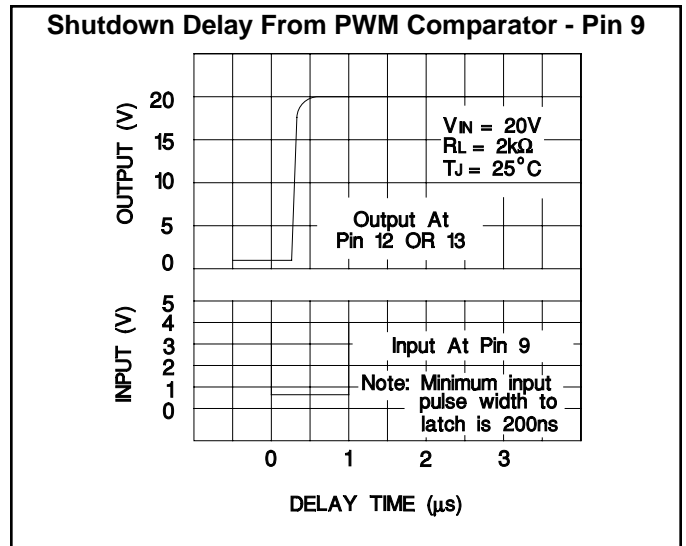
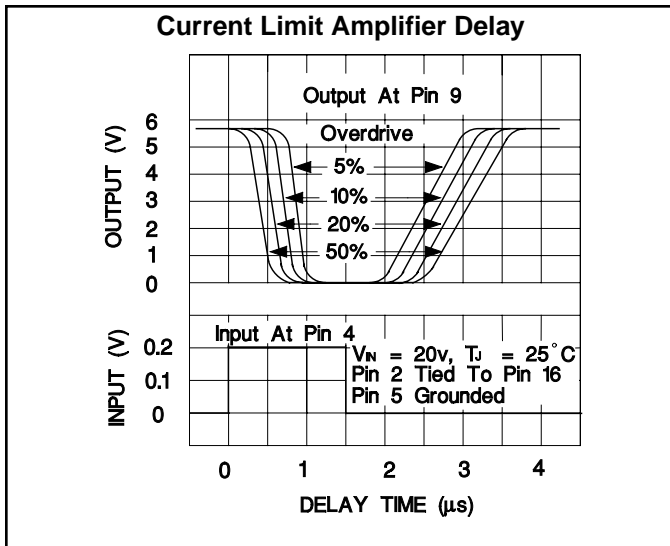
* These parameters are ensured by design but not 100% tested in production.

§ DC transconductance (gm) relates to DC open-loop voltage gain according to the following equation: $A_V = gmR_L$ where R_L is the resistance from pin 9 to the common mode voltage.

The minimum gm specification is used to calculate minimum A_V when the error amplifier output is loaded.

Note 1: Min Limit applies to output high level, max limit applies to output low level.





PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
5962-8764502EA	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC1524AJ	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC1524AJ/80503	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC1524AJ883B	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC1524AL	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
UC1524AL883B	ACTIVE	LCCC	FK	20	1	None	POST-PLATE	Level-NC-NC-NC
UC2524ADW	ACTIVE	SOIC	DW	16	40	None	CU NIPDAU	Level-2-220C-1 YEAR
UC2524ADWTR	ACTIVE	SOIC	DW	16	2000	None	CU NIPDAU	Level-2-220C-1 YEAR
UC2524AJ	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC2524AN	ACTIVE	PDIP	N	16	25	None	CU SNPB	Level-NA-NA-NA
UC2524ANG4	ACTIVE	PDIP	N	16	1000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-NA-NA-NA
UC3524ADW	ACTIVE	SOIC	DW	16	40	None	CU NIPDAU	Level-2-220C-1 YEAR
UC3524ADWTR	ACTIVE	SOIC	DW	16	2000	None	CU NIPDAU	Level-2-220C-1 YEAR
UC3524AJ	ACTIVE	CDIP	J	16	1	None	A42 SNPB	Level-NC-NC-NC
UC3524AN	ACTIVE	PDIP	N	16	25	None	CU SNPB	Level-NA-NA-NA

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - May not be currently available - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

None: Not yet available Lead (Pb-Free).

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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